

大睿股份有限公司

RoHS 限用物質含有量標示

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2	型號：A006 系列型號：mPOP, POP10, POP10CI 外接式電源供應器 ATS065-P241	第4頁 第17頁
3	型號：TSP100 系列型號：TSP143IIIU，TSP143IIILAN	第5頁
4	型號：TSP650 系列型號：TSP654IIC, TSP654IIE3, TSP654IID, TSP654IIU, TSP654IIE3X, TSP654IIBI2, TSP654IIHIX . 外接式電源供應器 DA-52C24	第6頁 第16頁
5	型號：TSP700 系列型號：TSP743IIC, TSP743IIE3, TSP743IID, TSP743IIU, TSP743IIE3X, TSP743IIBI2, TSP743IIHIX . 外接式電源供應器 DA-52C24	第7頁 第16頁
6	型號：TUP500 系列型號：TUP592C, TUP592D, TUP592U, TUP592E3, 外接式電源供應器 DA-52C24	第8頁 第16頁

7	型號：MCP20 外接式電源供應器 DA-52C24	第9頁 第16頁
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	系列型號：MCP31L，MCP30 外接式電源供應器 DA-52C24	第10頁 第16頁
9	型號：TSP100A 系列型號：TSP100IV，TSP143IV-UE， A007，BSC10II-UE，BSC10II-U	第11頁
10	型號：MCP21LB 外接式電源供應器 DA-52C24	第12頁 第16頁
11	型號：MCL32CI 外接式電源供應器 ATS065T-P241	第13頁 第17頁
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設備名稱：熱感式印表機 型號：A001（系列：BSC10UD , BSC10UC , BSC10E）

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：A006（系列：mPOP,POP10,POP10CI）

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %”及“超出0.01 wt %”係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○”係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-”係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TSP100（系列：TSP143IIIU , TSP143IIILAN）

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。
 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TSP650 系列：TSP654IIC,TSP654IIE3,TSP654IID, TSP654IIU, TSP654IIE3X, TSP654IIBI2, TSP654IIHIX						
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○
備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition. 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence. 備考3. “-” 係指該項限用物質為排除項目。 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.						

設備名稱：熱感式印表機 型號：TSP700
 系列：TSP743IIC,TSP743IIE3,TSP743IID, TSP743IIU, TSP743IIE3X, TSP743IIBI2, TSP743IIHIX

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.
 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.
 備考3. “-” 係指該項限用物質為排除項目。
 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TUP500
 系列：TUP592C,TUP592D,TUP592U,TUP592E3,

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply 型號：DA-52B24	○	○	○	○	○	○
電源供應器Power supply 型號：DA-52C24	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.
 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.
 備考3. “-” 係指該項限用物質為排除項目。
 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：MCP20

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	○	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。
 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：MCP31CI 系列：MCP31L , MCP30

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：TSP100A
 系列：TSP100IV , TSP143IV-UE , A007 ,BSC10II-UE , BSC10II-U

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.
 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.
 備考3. “-” 係指該項限用物質為排除項目。
 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：MCP21LB						
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	○	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○
<p>備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.</p> <p>備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.</p> <p>備考3. “-” 係指該項限用物質為排除項目。 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.</p>						

設備名稱：熱感式印表機 型號：MCL32CI

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：POP10CBI

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	○	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。
Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：熱感式印表機 型號：MCL21CI LBL

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼Enclosure	○	○	○	○	○	○
機構Mechanism	-	○	○	○	○	○
電路板總成 Printed circuit board	-	○	○	○	○	○
電源供應器Power supply	-	○	○	○	○	○
包裝Packages	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

設備名稱：電源供應器， Equipment name		型號（型式）：DA-52C24 Type designation (Type)				
單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
外殼	○	○	○	○	○	○
線材	—	○	○	○	○	○
插座	—	○	○	○	○	○
印刷電路板 (含插件)	—	○	○	○	○	○
標籤	○	○	○	○	○	○
備考1. “超出0.1 wt %”及“超出0.01 wt %”係指限用物質之百分比含量超出百分比含量基準值。 Note 1 : “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.						
備考2. “○”係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2 : “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.						
備考3. “—”係指該項限用物質為排除項目。 Note 3 : The “—” indicates that the restricted substance corresponds to the exemption.						

設備名稱：交換式電源供應器，型號（型式）：ATS065-P241

Equipment name Type designation (Type)

單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
上蓋	○	○	○	○	○	○
下蓋	○	○	○	○	○	○
電路板	○	○	○	○	○	○
插頭	○	○	○	○	○	○
線材	○	○	○	○	○	○
變壓器	○	○	○	○	○	○

備考 1. “超出 0.1 wt %” 及 “超出 0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考 2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考 3. “—” 係指該項限用物質為排除項目。

Note 3: The “—” indicates that the restricted substance corresponds to the exemption.